Appl. No. 10/712,239
Atty. Docket No. 9103M
Amendment dated January 25, 2006
Reply to Office Action of October 28, 2005
Customer No. 27752

## AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application:

## Listing of Claims:

- (Currently Amended) A nonwoven substrate comprising at least one first region and at least one second region, wherein said second region comprises protruding elements locked by a reinforcing means in the second region selected from the group consisting of thermal bonding, chemical bonding, ionic bonding, adhesive bonding and combinations thereof.
- (Original) The nonwoven substrate of Claim 1 wherein the nonwoven substrate comprises at least about 20% thermoplastic material and the protruding elements of the second region are locked by means of thermal bonding.
- 3. (Original) The nonwoven substrate of Claim 2 wherein the second region contains furrows and ridges.
- 4. (Original) The nonwoven substrate of Claim 3 wherein the second region provides abrasivity when the nonwoven substrate is utilized in cleaning.
- 5. (Original) A wet wipe comprising the nonwoven substrate of Claim 1.
- 6. (Original) A wet wipe of Claim 5 wherein a liquid is applied to the nonwoven substrate before use.
- (Original) A pre-moistened wet wipe of Claim 5 wherein a liquid is applied to the nonwoven substrate prior to packaging.
- 8. (Original) The wet wipe of Claim 5 wherein the nonwoven substrate is a laminate of webs comprising of at least one fibrous web.

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- 9. (Original) The wet wipe of Claim 7 wherein the amount of liquid added is in the range of from about 10% to about 500% by weight of the dry nonwoven substrate.
- 10. (Original) A wet wipe having a basis weight and a thickness, comprising:

a nonwoven substrate which is subject to a texturing process which does not increase the basis weight and

a liquid,

wherein the thickness of said wet wipe is at least about 30% greater than the thickness of the wet nonwoven substrate prior to being textured.

- 11. (Original) The wet wipe of Claim 10 wherein the thickness of said wet wipe after being subject to external forces is at least about 30% greater than the thickness of the wet non-textured nonwoven substrate after being subject to external forces.
- 12. (Withdrawn) A process for forming a textured substrate comprising:
  - a) providing a nonwoven substrate,
  - b) feeding said nonwoven substrate through a pair of corresponding rolls wherein at least one roll comprises a plurality of toothed and grooved regions about the circumference of the roll and the roll is heated,
  - c) forming a first region of the nonwoven substrate from said grooved regions, and
  - d) forming a second region of the nonwoven substrate from said toothed region.
- 13. (Withdrawn) The process according to Claim 12 wherein a liquid is applied to said textured substrate prior to packaging to form a premoistened wet wipe.
- 14. (Withdrawn) The process according to Claim 12 wherein a liquid is applied to said textured substrate prior to use to form a wet wipe.
- 15. (Withdrawn) A process for forming a textured substrate comprising:
  - a. providing a nonwoven substrate,
  - b. feeding said nonwoven substrate through a pair of corresponding plates wherein at least one plate comprises a plurality of toothed and grooved regions about the surface of the plate and the plate is heated,
  - c. forming a first region of the nonwoven substrate from said grooved regions, and

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- d. forming a second region of the nonwoven substrate from said toothed region.
- 16. (Withdrawn) The process according to Claim 15 wherein a liquid is applied to said textured substrate prior to packaging to form a premoistened wet wipe.
- 17. (Withdrawn) The process according to Claim 15 wherein a liquid is applied to said textured substrate prior to use to form a wet wipe.
- 18. (Withdrawn) A process for forming a textured substrate comprising:
  - a. providing a heated nonwoven substrate,
  - b. feeding said heated nonwoven substrate through a pair of corresponding plates or rolls wherein at least one plate or roll comprises a plurality of toothed and grooved regions about the surface of the plate or roll,
  - c. forming a first region of the nonwoven substrate from said grooved regions, and
  - d. forming a second region of the nonwoven substrate from said toothed region.
- 19. (Canceled)
- 20. (Canceled)